

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	8179	supercritical near fluid	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:48
L2	1113	precursor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:07
L3	0	silicon near precursor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:08
L4	6	silicon near3 precursor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:08
L5	1310	cyclosiloxane	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:08
L6	6	1 and 2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:08
L7	0	5 and 6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:09
L8	15	1 and 5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:09
L9	2	8 and (precursor) near15 (cyclosiloxane)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:13

L10	594	(barrier near3 precursor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:13
L11	1037	(barrier near5 precursor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:13
L12	8	1 and 11	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:14
L13	22420	(contact\$3 near zone)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:14
L14	2	12 and 13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:14
L15	2282	(copper or cu) near5 (metalliz\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:15
L16	0	(copper or cu) near5 (metalliz\$4) near3 (precursor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:17
L17	8	1 and 15	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:15
L18	2798	(copper or cu) near5 (precursor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:43
L19	45	1 and 18	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:18

L20	25	19 and (copper) with (wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:34
L21	25	19 and (copper) near10 (wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:35
L22	25	19 and (copper) near8 (wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:35
L23	24	19 and (copper) near5 (wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:37
L24	0	23 and (supercritica) with (copper or cu)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:37
L25	0	23 and (supercritica) same (copper or cu)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:38
L26	17	23 and (supercritical) same (copper or cu)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:38
L27	15	23 and (supercritical) with (copper or cu)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:42
L28	0	23 and (super-critical) with (copper or cu)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:42
L29	14	23 and (supercritical near fluid) with (copper or cu)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:42

L30	2245	(electrode) near5 (precursor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:43
L31	10	1 and 30	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:43
L32	4	31 and (supercritical) with (electrode)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:45
L33	4	31 and (supercritical near fluid) with (electrode)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:48
L34	6	31 and (supercritical near fluid) same (electrode)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:45
L35	8706	supercritical near3 fluid	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:48
L36	11	30 and 35	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:48
L37	4	36 and (supercritical near fluid) with (electrode)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:55
L38	1	(siloxane with alkylsilane)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:55
L39	1	(siloxane same alkylsilane)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:56

L40	0	35 and 39	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:56
L41	124	(siloxane same alkylsilane)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:56
L42	3	35 and 41	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 12:56

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	72	(precursor) with (barrier) same ((metal near nitride) or (metal near oxynitride))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 16:15
L2	51	(precursor) with (barrier) with ((metal near nitride) or (metal near oxynitride))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 16:15
L3	48	2 and (deposit\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 16:16
L4	34	2 and (deposit\$3 with material)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 16:17
L5	26	4 and (precursor near5 barrier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 16:17
L6	16	4 and (precursor near3 barrier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 16:17
L7	15	6 and (tantalum or ta)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 16:17